

JET dispenser application compatible Silver-Copper paste

JET dispenser coating method enables non-contact coating to the substrate from a distance. It is expected to be applied to the workpieces that are difficult to coat with screen printing, such as 3D curved surfaces.

Characteristic items	Ag/Cu paste ACPK-JD20
Type	1-component ・ Heat curing type
Viscosity@ 25°C	20～30dPa・s
Curing condition	130°C×60min 150°C×30min
Volume resistivity (reference)	$5.0 \times 10^{-4} \text{ } [\Omega \cdot \text{cm}]$
Features	After curing Can be soldered

[Conditions]

Application with JET dispenser (MUSASHI ENGINEERING, INC.)

Application speed : 150mm/sec

※ Please contact us regarding the equipment used.

[Application video]

Here is the link to the video→
(Youtube)

Video 1



Video 2



Video 1) <https://youtu.be/5gbpoympxHQ>

Video 2) <https://youtu.be/OKVYhiVQNKg>

